# PSMN4R4-80PS



# N-channel 80 V, 4.1 $m\Omega$ standard level FET

Rev. 01 — 18 June 2009

**Product data sheet** 

### 1. Product profile

### 1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

#### 1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Suitable for standard level gate drive sources

### 1.3 Applications

- DC DC converters
- Load switch

- Motor control
- Server power supplies

### 1.4 Quick reference data

Table 1. Quick reference

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$I_D$	drain current	$T_{mb}$ = 25 °C; $V_{GS}$ = 10 V; see <u>Figure 1</u> ; see <u>Figure 3</u>		-	-	100	Α
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	-	306	W
Dynamic	characteristics						
$Q_{GD}$	gate-drain charge	$V_{GS}$ = 10 V; $I_D$ = 80 A; $V_{DS}$ = 40 V; see <u>Figure 14</u> ; see <u>Figure 15</u>		-	25	-	nC
Static characteristics							
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 10 V; $I_D$ = 15 A; $T_j$ = 25 °C; see <u>Figure 6</u> ; see <u>Figure 13</u>	[1]	-	3.3	4.1	mΩ

<sup>[1]</sup> Measured 3 mm from package.



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# **Pinning information**

Table 2. **Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	D
3	S	source		$G \longrightarrow \overline{A}$
mb	D	drain		mbb076 S
			SOT78 (TO-220AB; SC-46)	

#### **Ordering information** 3.

Table 3. **Ordering information** 

Type number	Package					
	Name	Description	Version			
PSMN4R4-80PS	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78			

## **Limiting values**

Table 4. **Limiting values** 

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$	-	80	V
$V_{DGR}$	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$	-	80	V
$V_{GS}$	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; see <u>Figure 1</u> ; see <u>Figure 3</u>	-	100	Α
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; see <u>Figure 1</u> ; see <u>Figure 3</u>	-	100	Α
I <sub>DM</sub>	peak drain current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 3	-	680	Α
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	306	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-dr	ain diode				
Is	source current	$T_{mb} = 25  ^{\circ}C$	-	100	Α
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	680	Α
Avalanche	ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_D$ = 100 A; $V_{sup}$ ≤ 80 V; $R_{GS}$ = 50 Ω; unclamped	-	591	mJ

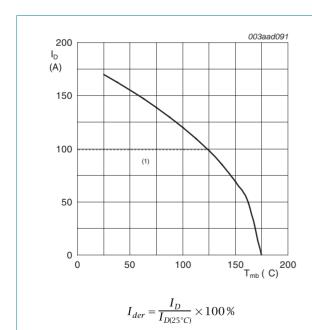
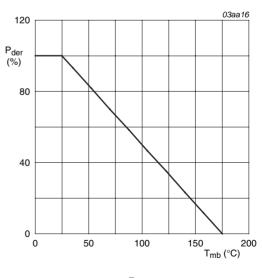
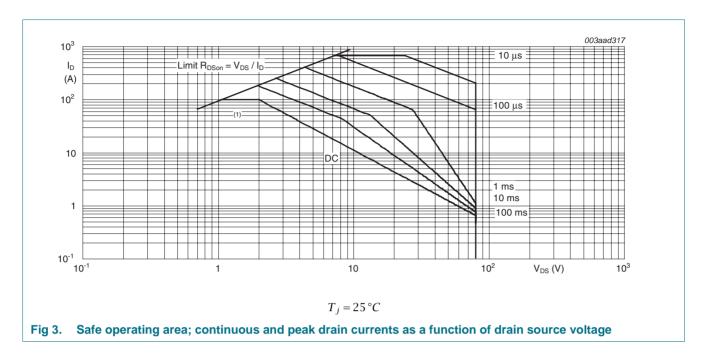


Fig 1. Normalized continuous drain current as a function of mounting base temperature



 $P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$ 

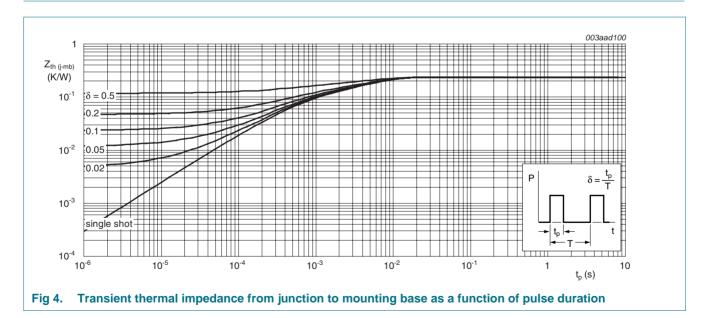
Fig 2. Normalized total power dissipation as a function of mounting base temperature



### 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	0.23	0.49	K/W



## 6. Characteristics

Table 6. Characteristics

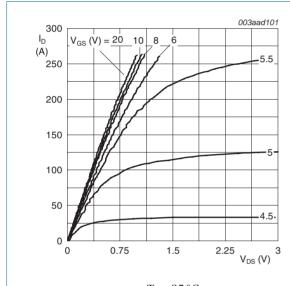
Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
$V_{(BR)DSS}$	drain-source	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^{\circ}C$		73	-	-	V
	breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 °C$		80	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1 \text{ mA}$ ; $V_{DS} = V_{GS}$ ; $T_j = 175 \text{ °C}$ ; see Figure 11		1	-	-	V
		$I_D = 1 \text{ mA}$ ; $V_{DS} = V_{GS}$ ; $T_j = -55 \text{ °C}$ ; see Figure 11		-	-	4.6	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$ ; $T_j = 25$ °C; see <u>Figure 11</u> ; see <u>Figure 12</u>		2	3	4	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	10	μΑ
		$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	200	μΑ
$I_{GSS}$	gate leakage current	$V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
		$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
R <sub>DSon</sub> drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A}; T_j = 175 \text{ °C};$ see Figure 13	[2]	-	7.6	9.47	mΩ	
		$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A}; T_j = 100 \text{ °C};$ see Figure 13		-	5.5	6.8	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A}; T_j = 25 \text{ °C};$ see Figure 6; see Figure 13	[2]	-	3.3	4.1	mΩ
$R_G$	internal gate resistance (AC)	f = 1 MHz		-	1	-	Ω
Dynamic o	characteristics						
Q <sub>G(tot)</sub> to	total gate charge	$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$		-	112	-	nC
		I <sub>D</sub> = 80 A; V <sub>DS</sub> = 40 V; V <sub>GS</sub> = 10 V; see <u>Figure 14</u> ; see <u>Figure 15</u>		-	125	-	nC
Q <sub>GS</sub>	gate-source charge	$I_D = 80 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$		-	39	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate-source charge	see <u>Figure 14</u> ; see <u>Figure 15</u>		-	24	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate-source charge			-	15	-	nC
$Q_{GD}$	gate-drain charge			-	25	-	nC
$V_{GS(pl)}$	gate-source plateau voltage	$I_D = 25 \text{ A}$ ; $V_{DS} = 40 \text{ V}$ ; see Figure 14; see Figure 15		-	4.65	-	V
C <sub>iss</sub>	input capacitance	$V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$		-	8400	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; see <u>Figure 16</u>		-	700	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	336	-	pF
d(on)	turn-on delay time	$V_{DS} = 40 \text{ V}; R_L = 0.5 \Omega; V_{GS} = 10 \text{ V};$		-	34.7	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 1.5 \Omega$		-	38.1	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	66	-	ns
t <sub>f</sub>	fall time			-	18.4	-	ns

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Table 6. Characteristics ... continued

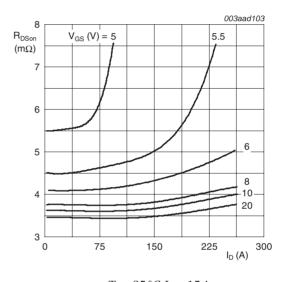
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-dr	rain diode					
V <sub>SD</sub>	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C};$ see <u>Figure 17</u>	-	0.8	1.2	V
t <sub>rr</sub>	reverse recovery time	$I_S = 25 \text{ A}$ ; $dI_S/dt = 100 \text{ A/}\mu\text{s}$ ; $V_{GS} = 0 \text{ V}$ ;	-	59	-	ns
$Q_r$	recovered charge	$V_{DS} = 20 \text{ V}$	-	130	-	nC

- [1] Tested to JEDEC standards where applicable.
- [2] Measured 3 mm from package.



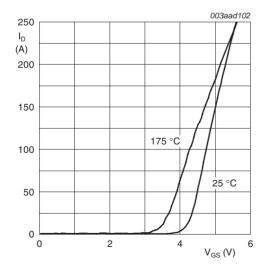
 $T_j = 25 \,^{\circ}C$ 

Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values



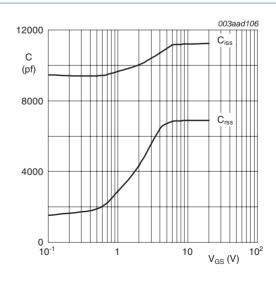
 $T_j = 25 \,^{\circ}C; I_D = 15A$ 

Fig 6. Drain-source on-state resistance as a function of drain current; typical values



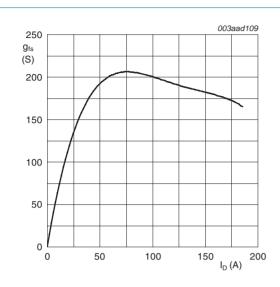
 $V_{DS} > I_D \times R_{DSon}$ 

Fig 7. Transfer characteristics: drain current as a function of gate-source voltage; typical values



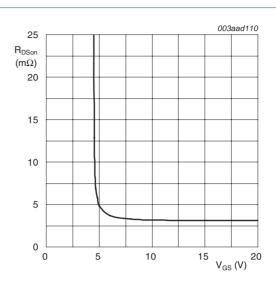
 $V_{DS} = 0\,V; f = 1MHz$ 

Fig 8. Input and reverse transfer capacitances as a function of gate-source voltage; typical values



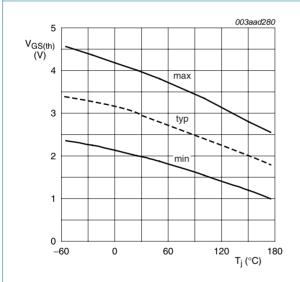
 $T_j = 25 \,{}^{\circ}C; V_{DS} = 25 \, V$ 

Fig 9. Forward transconductance as a function of drain current; typical values



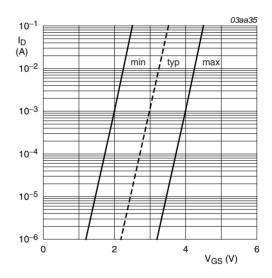
$$T_j = 25\,^{\circ}C; I_D = 15A$$

Fig 10. Drain-source on-state resistance as a function of gate-source voltage; typical values



 $I_D = 1 \, mA; V_{DS} = V_{GS}$ 

Fig 11. Gate-source threshold voltage as a function of junction temperature



$$T_i = 25 \,^{\circ}C; V_{DS} = 5V$$

Fig 12. Sub-threshold drain current as a function of gate-source voltage

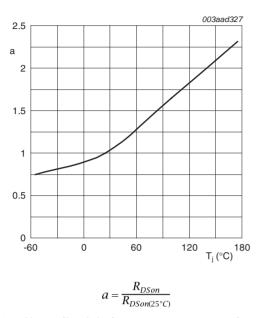
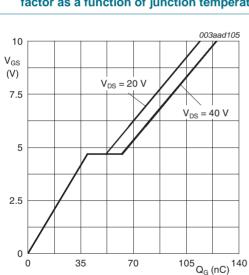


Fig 13. Normailzed drain-source on-state resistance factor as a function of junction temperature



 $I_D = 80A \label{eq:ID}$  Fig 15. Gate-source voltage as a function of gate charge; typical values

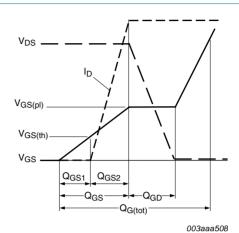
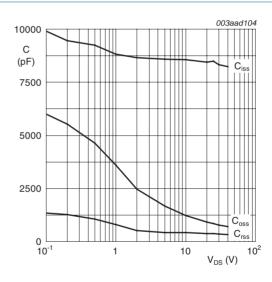


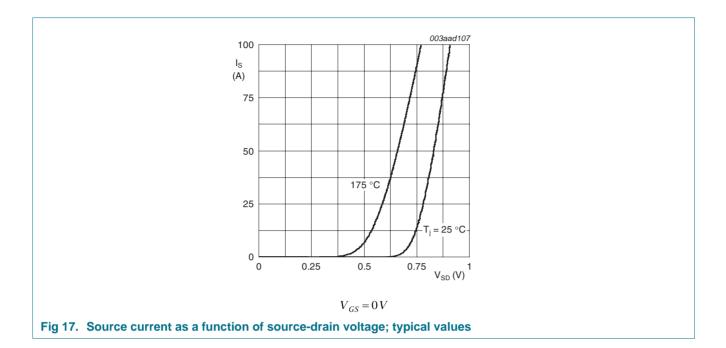
Fig 14. Gate charge waveform definitions



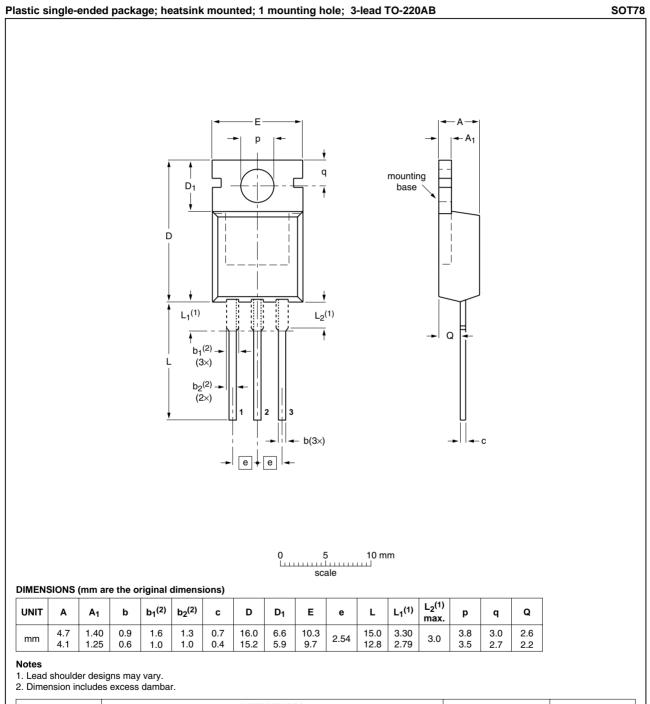
 $V_{GS} = 0V; f = 1MHz$ 

Fig 16. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

N-channel 80 V, 4.1 m $\Omega$  standard level FET



## 7. Package outline



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT78		3-lead TO-220AB	SC-46		<del>08-04-23</del> 08-06-13

Fig 18. Package outline SOT78 (TO-220AB)

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N-channel 80 V, 4.1 m $\Omega$  standard level FET

# **Revision history**

#### Table 7. **Revision history**

**Product data sheet** 

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN4R4-80PS_1	20090618	Product data sheet	-	-

#### N-channel 80 V, 4.1 mΩ standard level FET

### 9. Legal information

### 9.1 Data sheet status

Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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